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PATENT

Docket No. JCLA8166

Date: 2-15-2002

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ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Jen-Jiann Chiou; Pei-Hung Chu

For: VIA HOLE DEFINING PROCESS PERFORMED IN ONE CHAMBER

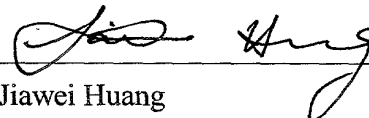
Enclosed are:

- ☒ Specification 9 pages.
- ☒ 4 Sheets of drawings
- ☒ Recordation Form Cover sheet with 2 pages assignment.
- ☐ A certified copy of Taiwan Patent Application No. dated .
- ☒ **SIGNED** declaration and power of attorney.
- ☒ Return Prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED					NUMBER EXTRA	RATE	FEE
Basic Fee							\$740.00	\$740.00
Total Claims	23	—	20	=	3	×	\$18.00	\$54.00
Independent Claims	2	—	3	=	0	×	\$84.00	\$0.00
If application contains any multiple dependent claim(s), then add							\$280.00	\$0.00
TOTAL FILING FEE								\$794.00

- ☒ A check in the amount of \$794.00 cover the filing fee is enclosed.
- ☒ A check in the amount of \$40.00 to cover the assignment recording fee.
- ☒ A duplicate copy of this sheet is enclosed.


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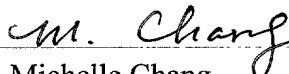
Docket No. : JCLA8166
Applicant(s) : Jen-Jiann Chiou; Pei-Hung Chu
For : VIA HOLE DEFINING PROCESS
PERFORMED IN ONE CHAMBER
"Express Mail" : EV 016847615 US
Mailing Label No.

Date of Deposit : Feb. 15, 2002

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 9 pages, 4 sheets of drawings; **SIGNED**
Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and
Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to
Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the
Assistant Commissioner for Patents, Washington, D.C. 20231.


Michelle Chang